SCBS057G - DECEMBER 1990 - REVISED MAY 1997

 Members of the Texas Instruments Widebus[™] Family 	SN54ABT16 SN74ABT16500B		R DL PACKAGE
 State-of-the-Art EPIC-IIB[™] BiCMOS Design Significantly Reduces Power Dissipation 	OEAB [GND
 UBT[™] (Universal Bus Transceiver) Combines D-Type Latches and D-Type 	LEAB [A1 [] CLKAB] B1
Flip-Flops for Operation in Transparent, Latched, or Clocked Mode	GND [A2 [] GND] B2
 ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015 	A3 [V _{CC} [7 50] вз] V _{CC}
 Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17 	A4 [A5 [8 49 9 48] B4] B5
 Typical V_{OLP} (Output Ground Bounce) < 0.8 V at V_{CC} = 5 V, T_A = 25°C 	A6 [GND [11 46] B6] GND
 High-Impedance State During Power Up and Power Down 	A7 [A8 [A9 [13 44] B7] B8] B9
 Flow-Through Architecture Optimizes PCB Layout 	A9 [A10 [A11 [15 42] B10] B11
 Package Options Include Plastic 300-mil Shrink Small-Outline (DL) and Thin Shrink 	A12 [GND [17 40] B12] GND
Small-Outline (DGG) Packages and 380-mil Fine-Pitch Ceramic Flat (WD) Package	A13 [A14 [19 38] B13] B14
Using 25-mil Center-to-Center Spacings	A15 [V _{CC} [21 36] B15] V _{CC}
description	A16 [A17 [23 34] B16] B17
These 18-bit universal bus transceivers combine D-type latches and D-type flip-flops to allow data	GND [A18 [25 32] GND] B18
flow in transparent, latched, and clocked modes.	OEBA [27 30	CLKBA

Data flow in each direction is controlled by output-enable (OEAB and OEBA), latch-enable (LEAB and LEBA), and clock (CLKAB and CLKBA) inputs. For A-to-B data flow, the device operates in the transparent mode when LEAB is high. When LEAB is low, the A data is latched if CLKAB is held at a high or low logic level. If LEAB is low, the A data is stored in the latch/flip-flop on the high-to-low transition of CLKAB. OEAB is active-high. When OEAB is high, the outputs are active. When OEAB is low, the outputs are in the high-impedance state.

Data flow for B to A is similar to that of A to B but uses OEBA, LEBA, and CLKBA. The output enables are complementary (OEAB is active high and OEBA is active low).

LEBA 28

29 GND



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description (continued)

When V_{CC} is between 0 and 2.1 V, the device is in the high-impedance state during power up or power down. However, to ensure the high-impedance state above 2.1 V, OE should be tied to V_{CC} through a pullup resistor and OE should be tied to GND through a pulldown resistor; the minimum value of the resistor is determined by the current-sinking/current-sourcing capability of the driver.

The SN54ABT16500B is characterized for operation over the full military temperature range of -55°C to 125°C. The SN74ABT16500B is characterized for operation from -40°C to 85°C.

				_
	OUTPUT			
OEAB	LEAB	CLKAB	Α	В
L	Х	Х	Х	Z
н	Н	Х	L	L
н	Н	Х	Н	н
н	L	\downarrow	L	L
н	L	\downarrow	Н	н
н	L	Н	Х	в ₀ ‡ в ₀ §
н	L	L	Х	в ₀ §
±				

FUNCTION TABLE[†]

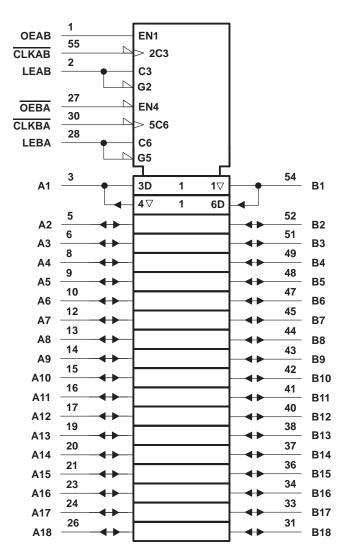
[†]A-to-B data flow is shown: B-to-A flow is similar but uses OEBA, LEBA, and CLKBA.

[‡]Output level before the indicated steady-state input conditions were established

§ Output level before the indicated steady-state input conditions were established, provided that CLKAB was low before LEAB went low



logic symbol[†]



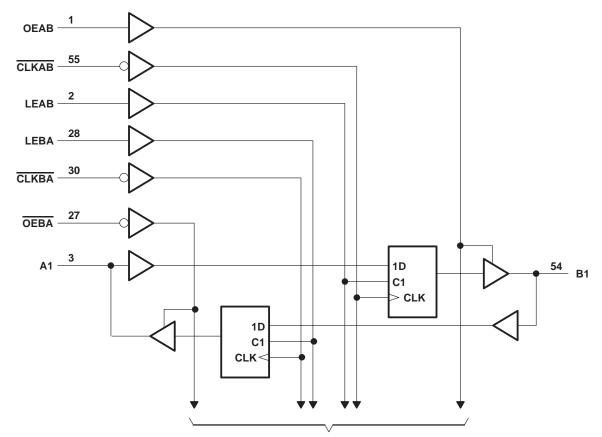
[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



SN54ABT16500B, SN74ABT16500B 18-BIT UNIVERSAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS SCBS057G – DECEMBER 1990 – REVISED MAY 1997

SCESSTG - DECEMBER 1990 - REVISED MAT 1

logic diagram (positive logic)



To 17 Other Channels

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V _{CC} Input voltage range, V _I (except I/O ports) (see Note 1)	\ldots –0.5 V to 7 V
Voltage range applied to any output in the high or power-off state, Vo	–0.5 V to 5.5 V
Current into any output in the low state, IO: SN54ABT16500B	96 mA
SN74ABT16500B	128 mA
Input clamp current, I _{IK} (V _I < 0)	–18 mA
Output clamp current, I _{OK} (V _O < 0)	
Package thermal impedance, θ_{JA} (see Note 2): DGG package	81°C/W
DL package	
Storage temperature range, T _{stg}	–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

2. The package thermal impedance is calculated in accordance with EIA/JEDEC Std JESD51.



SN54ABT16500B, SN74ABT16500B **18-BIT UNIVERSAL BUS TRANSCEIVERS** WITH 3-STATE OUTPUTS SCBS057G – DECEMBER 1990 – REVISED MAY 1997

recommended operating conditions (see Note 3)

			SN54ABT	16500B	SN74ABT	16500B	UNIT
			MIN	MAX	MIN	MAX	UNIT
VCC	Supply voltage		4.5	5.5	4.5	5.5	V
VIH	High-level input voltage		2	N	2		V
VIL	Low-level input voltage			0.8		0.8	V
VI	Input voltage		0	Vcc	0	VCC	V
ЮН	High-level output current		4	-24		-32	mA
IOL	Low-level output current		200	48		64	mA
$\Delta t/\Delta v$	Input transition rise or fall rate	Outputs enabled	20%	10		10	ns/V
Δt/ΔV _{CC}	Power-up ramp rate		200		200		μs/V
TA	Operating free-air temperature		-55	125	-40	85	°C

NOTE 3: Unused pins (input or I/O) must be held high or low to prevent them from floating.



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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST OO	Т	A = 25°C	;	SN54ABT	SN54ABT16500B		SN74ABT16500B		
			TEST CONDITIONS			MAX	MIN	MAX	MIN	MAX	UNIT
VIK		$V_{CC} = 4.5 V$, $I_{I} = -18 mA$			÷	-1.2		-1.2		-1.2	V
		V _{CC} = 4.5 V,	I _{OH} = –3 mA	2.5			2.5		2.5		
		V _{CC} = 5 V,	I _{OH} = –3 mA	3			3		3		N
VOH			I _{OH} = -24 mA	2			2				V
		$V_{CC} = 4.5 V$	I _{OH} = -32 mA	2*					2		
Vai			I _{OL} = 48 mA			0.55		0.55			V
VOL		$V_{CC} = 4.5 V$	I _{OL} = 64 mA			0.55*				0.55	V
V _{hys}			-		100						mV
loff		V _{CC} = 0,	$V_{I} \text{ or } V_{O} \leq 4.5 \text{ V}$			±100				±100	μΑ
ICEX		V _{CC} = 5.5 V, V _O = 5.5 V	Outputs high			50		50		50	μA
1.	Control inputs	$V_{CC} = 0 \text{ to } 5.5 \text{ V}, V_{I} = V_{CC} \text{ or GND}$ $V_{CC} = 2.1 \text{ V to } 5.5 \text{ V},$ $V_{I} = V_{CC} \text{ or GND}$				±1		1		±1	
łı	A or B ports					±20	à	±20		±20	μA
lo‡		V _{CC} = 5.5 V,	V _O = 2.5 V	-50	-100	-180	-50	-180	-50	-180	mA
IOZPU	§ر	$V_{CC} = 0 \text{ to } 2.1 \text{ V},$ $V_{O} = 0.5 \text{ V to } 2.7 \text{ V}$	$V, \overline{OE} \text{ or } OE = X$			±50	ROD	±50		±50	μΑ
IOZPE	D§	$V_{CC} = 2.1 V \text{ to } 0,$ $V_{O} = 0.5 V \text{ to } 2.7 V$	$V, \overline{OE} \text{ or } OE = X$			±50	~	±50		±50	μΑ
IOZH	Т	$\frac{V_{CC}}{OE} = 2.1 \text{ V to } 5.5 \text{ OE} \ge 2 \text{ V, OE} \le 0.8 \text{ OE}$	V, V _O = 2.7 V, V [#]			10		10		10	μΑ
IOZL	ſ	$\frac{V_{CC}}{OE} = 2.1 \text{ V to } 5.5 \text{ OE} \ge 2 \text{ V, OE} \le 0.8 \text{ OE}$	V, V _O = 0.5 V, V#			-10		-10		-10	μΑ
		V _{CC} = 5.5 V,	Outputs high			3		3		3	
ICC	A or B ports	$I_{O} = 0,$	Outputs low			36		36		36	mA
		VI = VCC or GND Outputs disabled				3		3		3	
∆ICC		V_{CC} = 5.5 V, One input at 3.4 V, Other inputs at V_{CC} or GND				50		50		50	μΑ
Ci	Control inputs	V _I = 2.5 V or 0.5 V			3						pF
Cio	A or B ports	$V_{O} = 2.5 \text{ V or } 0.5 \text{ V}$	V		9						pF

* On products compliant to MIL-PRF-38535, this parameter does not apply.

[†] All typical values are at $V_{CC} = 5 V$.

* Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

§ This parameter is characterized, but not production tested.

 \P The parameters I_{OZH} and I_{OZL} include the input leakage current.

[#] For V_{CC} between 2.1 V and 4 V, OE should be less than or equal to 0.5 V to ensure a low state.

This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.



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timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)

				SN54ABT	16500B	SN74ABT1	6500B	UNIT
				MIN	MAX	MIN	MAX	UNIT
fclock	Clock frequency			0	150	0	150	MHz
· +	Dulas duration	LEAB or LEBA high		2.5	Ł	2.5		
t _w †	Pulse duration CLKAB or CLKBA high or low			3	N	3		ns
		A before CLKAB↓		3	24	3		
	Cotup time	B before CLKBA↓	3	2	3			
t _{su}	Setup time	A before LEAB↓ or B before LEBA↓	CLK high	20		1		ns
			CLK low	2.5		2.5		
4	Hold time	A after $\overline{\text{CLKAB}}\downarrow$ or B after $\overline{\text{CLKBA}}\downarrow$	v 0		0			
th		A after LEAB \downarrow or B after LEBA \downarrow	2		2		ns	

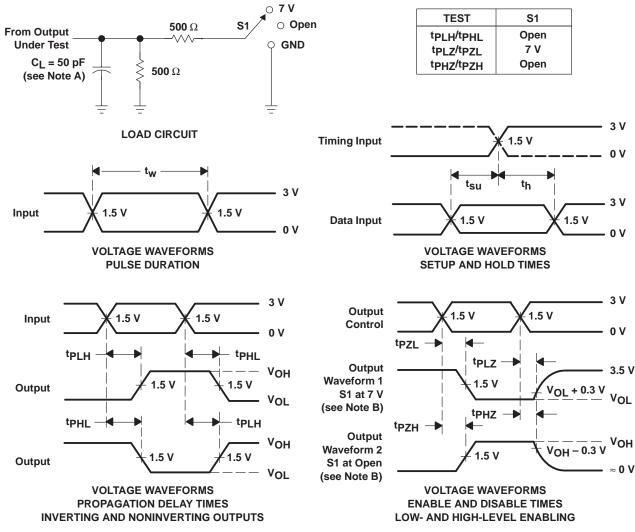
[†] This parameter is characterized, but not production tested.

switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	FROM TO (INPUT) (OUTPUT)		$T_{\Delta} = 25^{\circ}C$		SN54ABT	16500B	SN74ABT	UNIT	
		(001101)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	
fmax			150	200		150		150		MHz
^t PLH	A or B	B or A	1	2.5	3.6	1	4.2	1	4	ns
^t PHL	AUB	BUIA	1	3.2	4.5	1	5.1	1	4.9	115
^t PLH		B or A	1	3.2	4.5	1	5.6	1	5	ns
^t PHL	LEAB or LEBA	BUIA	1	3.4	4.5	1	5.4	1	5	115
^t PLH	CLKAB or CLKBA	B or A	1	3.5	4.7	1	5.4	1	5.3	ns
^t PHL	CLKAB OF CLKBA	BUIA	1	3.5	4.7	570	5.4	1	5.3	115
^t PZH		B or A	1	3.4	4.6	01	5.3	1	5.1	ns
^t PZL	OEAB or OEBA	BUIA	1.5	3.8	4.7	Q 1.5	5.6	1.5	5.4	115
^t PHZ	OEAB or OEBA	B or A	1.5	4.5	5.7	1.5	6.9	1.5	6.5	ns
^t PLZ	OLAD OF OEDA	BUIA	1.4	3.4	4.7	1.4	5.8	1.4	5.4	115



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PARAMETER MEASUREMENT INFORMATION

NOTES: A. CL includes probe and jig capacitance.

B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.

C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_O = 50 Ω , t_f \leq 2.5 ns. t_f \leq 2.5 ns.

D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal												
Device	-	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74ABT16500BDGGR	TSSOP	DGG	56	2000	330.0	24.4	8.6	15.6	1.8	12.0	24.0	Q1
SN74ABT16500BDLR	SSOP	DL	56	1000	330.0	32.4	11.35	18.67	3.1	16.0	32.0	Q1



PACKAGE MATERIALS INFORMATION

11-Mar-2008



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74ABT16500BDGGR	TSSOP	DGG	56	2000	346.0	346.0	41.0
SN74ABT16500BDLR	SSOP	DL	56	1000	346.0	346.0	49.0

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